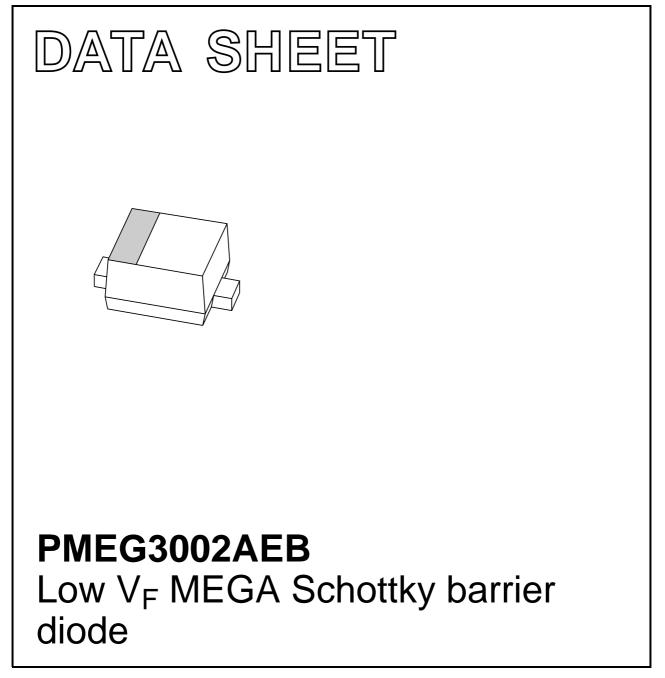
DISCRETE SEMICONDUCTORS



Product data sheet

2002 May 06



FEATURES

- Forward current: 0.2 A
- Reverse voltage: 30 V
- Very low forward voltage
- Ultra small SMD package.

APPLICATIONS

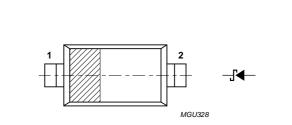
- Ultra high-speed switching
- High efficiency DC/DC conversion
- Voltage clamping
- Inverse-polarity protection
- · Low voltage rectification
- Low power consumption applications.

DESCRIPTION

Planar Maximum Efficiency General Application (MEGA) Schottky barrier diode with an integrated guard ring for stress protection, encapsulated in a SOD523 (SC-79) ultra small SMD plastic package.

PINNING

PIN	DESCRIPTION	
1	cathode	
2	anode	



Marking code: B1. The marking bar indicates the cathode.

Fig.1 Simplified outline (SOD523; SC-79) and symbol.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _R	continuous reverse voltage		-	30	V
I _F	continuous forward current		-	200	mA
I _{FRM}	repetitive peak forward current	$t_p \le 1 \text{ s}; \delta \le 0.5$	-	300	mA
I _{FSM}	non-repetitive peak forward current	t _p = 8.3 ms half sinewave; JEDEC method	_	1	А
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	125	°C
T _{amb}	operating ambient temperature		-65	+125	°C

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ELECTRICAL CHARACTERISTICS

 T_{amb} = 25 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V _F	continuous forward voltage	see Fig.2			
		I _F = 0.1 mA	130	190	mV
		I _F = 1 mA	190	250	mV
		I _F = 10 mA	255	300	mV
		I _F = 100 mA	355	400	mV
		I _F = 200 mA	420	480	mV
I _R	continuous reverse current	$V_R = 10 V$; see Fig.3; note 1	2.5	10	μA
C _d	diode capacitance	$V_R = 1 V$; f = 1 MHz; see Fig.4	20	25	pF

Note

1. Pulsed test: t_p = 300 µs; δ = 0.02.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	note 1	450	K/W

Note

1. Refer to SOD523 (SC-79) standard mounting conditions.

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GRAPHICAL DATA

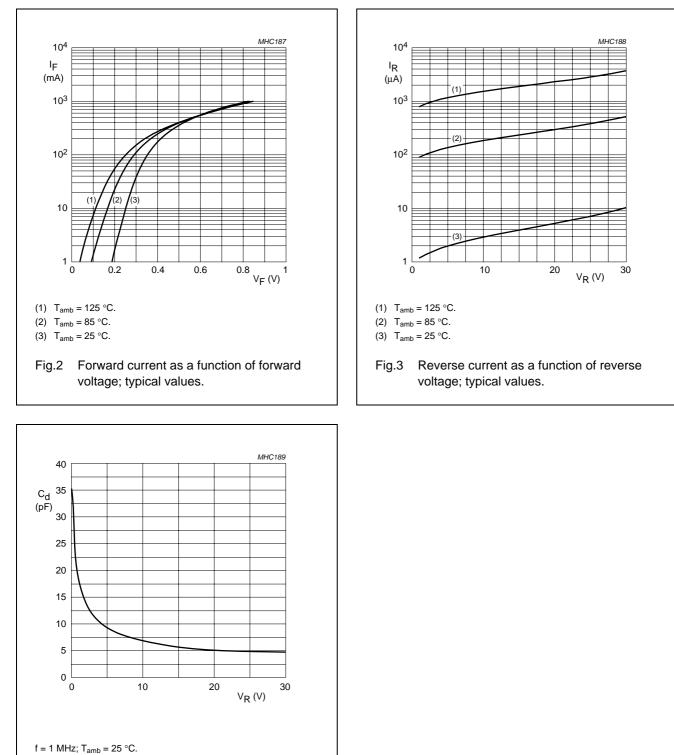


Fig.4 Diode capacitance as a function of reverse voltage; typical values.

Product data sheet

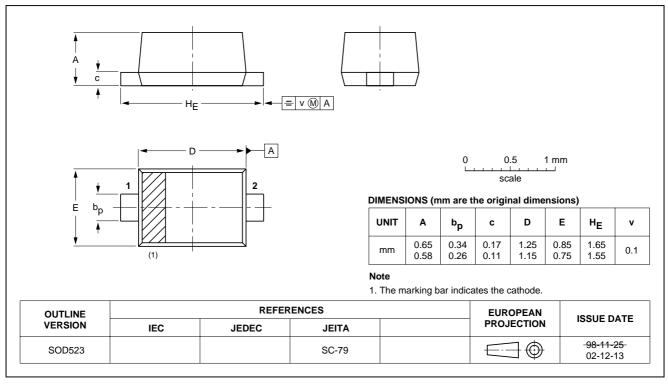
SOD523

Low V_F MEGA Schottky barrier diode

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PACKAGE OUTLINE

Plastic surface mounted package; 2 leads



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DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

- 1. Please consult the most recently issued document before initiating or completing a design.
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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